

RoHS

COMPLIANT



Power	MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	400 V			
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	1.8		
Q _g (Max.) (nC)	20			
Q _{gs} (nC)	3.3			
Q _{gd} (nC)	11			
Configuration	Single			





N-Channel MOSFET

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and/or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information/tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF720PbF		
Leau (FD)-free	SiHF720-E3		
SnPb	IRF720		
	SiHF720		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage				400	V
•			V _{DS}		V
Gate-Source Voltage			V _{GS}	± 20	V
Continuous Drain Current	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	ID	3.3	
	VGS at 10 V	$T_{C} = 100 ^{\circ}C$	טי	2.1	А
Pulsed Drain Current ^a	I _{DM}	13			
Linear Derating Factor				0.40	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	190	mJ
Repetitive Avalanche Current ^a			I _{AR}	3.3	А
Repetitive Avalanche Energy ^a			E _{AR}	5.0	mJ
Maximum Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			P _D	50	W
Peak Diode Recovery dV/dt ^c			dV/dt	4.0	V/ns
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	•••
Soldering Recommendations (Peak Temperature) ^d for 10 s				300	°C
Manuatia a Tanana	6-32 or M3 screw			10	lbf ⋅ in
Mounting Torque			_	1.1	N · m

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 30 mH, $R_g = 25 \Omega$, $I_{AS} = 3.3$ A (see fig. 12). c. $I_{SD} \le 3.3$ A, $dI/dt \le 65$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

S14-2355-Rev. C, 08-Dec-14

1

Document Number: 91043



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	_	2.5	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		*		*	•		•
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 250 μA	400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference t	o 25 °C, I _D = 1 mA	-	0.51	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_0$	_{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	Vo	_{GS} = ± 20	-	-	± 100	nA
		$V_{DS} = 40$	00 V, V _{GS} = 0 V	-	-	25	1
Zero Gate Voltage Drain Current	I _{DSS}		′ _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		-	-	1.8	Ω
Forward Transconductance	g _{fs}	V _{DS} = 50	0 V, I _D = 2.0 A ^b	1.7	-	-	S
Dynamic		•		*	•	•	•
Input Capacitance	C _{iss}	V	_{GS} = 0 V,	-	410	-	pF
Output Capacitance	C _{oss}		$_{\rm OS} = 25 \rm V,$	-	120	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 M	MHz, see fig. 5	-	47	-	
Total Gate Charge	Qg		I _D = 3.3 A,		-	20	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 320 V,$	-	-	3.3	nC
Gate-Drain Charge	Q _{gd}		see fig. 6 and 13 ^b	-	-	11	
Turn-On Delay Time	t _{d(on)}				10	-	- ns
Rise Time	t _r	V _{DD} = 200 V, I _D = 3.3 A		-	14	-	
Turn-Off Delay Time	t _{d(off)}		$V_{DD} = 200 \text{ V}, \text{ I}_D = 3.3 \text{ A}$ $R_a = 18 \Omega, R_D = 56 \Omega, \text{ see fig. 10 }^{\text{b}}$		30	-	
Fall Time	t _f	g , j , j , , , , , , , , , , , , , , ,		-	13	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	L _S			-	7.5	-	nH
Drain-Source Body Diode Characteristic	s	·				-	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.3	А
Pulsed Diode Forward Current ^a	I _{SM}			-	-	13	
Body Diode Voltage	V _{SD}	T_J = 25 °C, I_S = 3.3 A, V_{GS} = 0 V ^b		-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	$T_{\rm J}$ = 25 °C, I _F = 3.3 A, dl/dt = 100 A/µs ^b		-	270	600	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	1.4	3.0	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				L _D)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

2



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^\circ C$



Fig. 3 - Typical Transfer Characteristics



Fig. 4 - Normalized On-Resistance vs. Temperature



Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

S14-2355-Rev. C, 08-Dec-14

3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91043

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000





Fig. 7 - Typical Source-Drain Diode Forward Voltage



Fig. 8 - Maximum Safe Operating Area



Fig. 9 - Maximum Drain Current vs. Case Temperature



Fig. 10a - Switching Time Test Circuit



Fig. 10b - Switching Time Waveforms



Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

S14-2355-Rev. C, 08-Dec-14

4

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

IRF720, SiHF720

Vishay Siliconix



Vishay Siliconix



Fig. 12a - Unclamped Inductive Test Circuit



Fig. 12b - Unclamped Inductive Waveforms



Fig. 12c - Maximum Avalanche Energy vs. Drain Current



Fig. 13a - Basic Gate Charge Waveform



Fig. 13b - Gate Charge Test Circuit





Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91043.



www.vishay.com

TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
AS	3E	Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by Vishay manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 2N7000 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C IPS70R2K0CEAKMA1 BUK954R8-60E DMN3404LQ-7 NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B